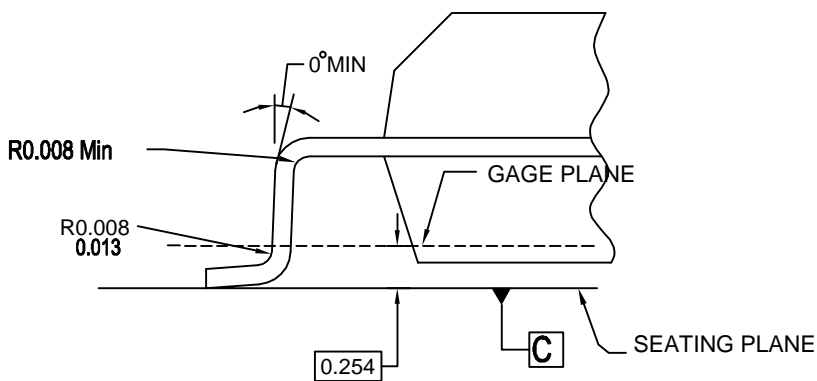
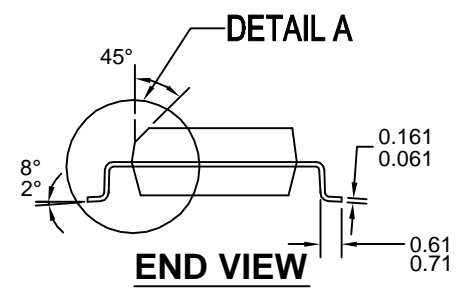
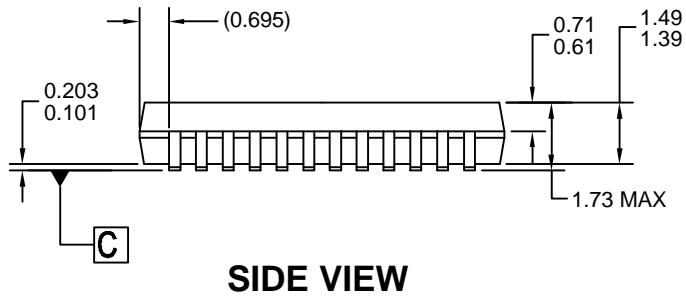
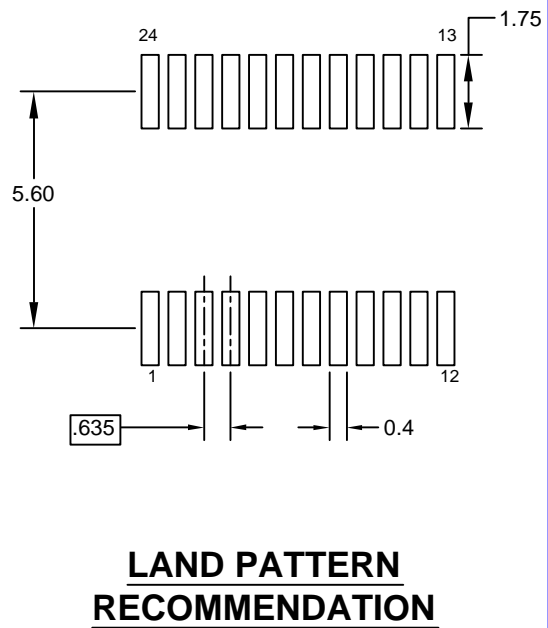
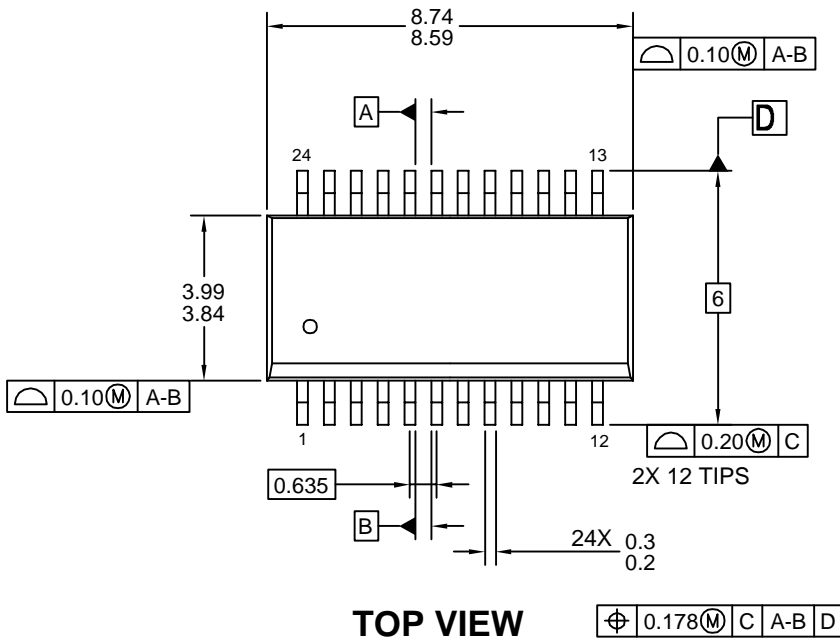


REVISIONS				
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D
2	RECREATED DRAWING	MASS UPDATE	17 JULY 07	L.HUEBENER



**NOTES :**

- A. THIS PACKAGE CONFORMS TO JEDEC M0-137 VARIATION AE
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DRAWING CONFORMS TO ASME Y14.5M-1994
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- E. LAND PATTERN STANDARD: SOP63P600X175-24M
- F. DRAWING FILE NAME: MKT-MQA24REV2

APPROVALS		DATE	FAIRCHILD SEMICONDUCTOR®		
DRAWN	L.HUEBENER	17 JULY 07		24LD, QSOP, JEDEC MO-137, 3.9 MM WIDE	
DFTG. CHK.	H.ALLEN	30 JULY 07			
ENGR. CHK.					
PROJECTION		SCALE	SIZE	DRAWING NUMBER	REV
		N/A	N/A	MKT-MQA24	2
DO NOT SCALE DRAWING				SHEET 1 of 1	